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Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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HF **PLED Series**

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Agency Approvals - PENDING

Agency	Agency File Number
IR ®	E133083

Schematic Symbol



Description

The open LED protector provides a switching electronic shunt path when an LED in an LED array fails as an open circuit. This ensures that the entire array of LEDs will continue to function even if a single LED in the array does not. This provides higher reliable lighting functions in applications such as headlights, aircrafts, aircraft runway lighting, roadside warning lights, etc. This device is compatible with one, two and three watt LEDs that have a nominal 3V forward characteristic. The PLED series is available in two surface mount packages, the DO-214 and the Quad Flat Pak No-lead (QFN). The QFN's low profile, chip scale package (CSP) is ideal for dense board applications.

Features & Benefits

- Fast switching
- Automatically resets after power cycle
- Available in low profile, small footprint QFN and Standard DO214AA packages
- Compatible with industrial lighting environments
- Compatible with PWM dimming speeds of up to 10 KHz

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• RoHS compliant and halogen-free

Electrical Characteristics									
	Marking	V _{BR} breakdown Volts		V _{DRM} breakdown	I _H	۱ _s	I _T @V _T	V _T @ I _T = 1 Amp	Critical rate of rise dV/dt
Part Number				Volts	mAmps	mAmps	Amps	Volts	Volts
		Min	Max	Min	Min	Max	Max	Max	Max
PLED6Q12	PL6	6	16	6	5	100	1.0	1.5	250V/µs
PLED6S	PL6	6	16	6	5	100	1.0	1.5	250V/µs
PLED9Q12	PL9	9	18	9	5	100	1.0	1.5	250V/µs
PLED9S	PL9	9	18	9	5	100	1.0	1.5	250V/µs
PLED13Q12	PL13	13	26	13	5	100	1.0	1.5	250V/µs
PLED13S	PL13	13	26	13	5	100	1.0	1.5	250V/µs
PLED18Q12	PL18	18	33	18	5	100	1.0	1.5	250V/µs
PLED18S	PL18	18	33	18	5	100	1.0	1.5	250V/µs



Thermal Resistance: Junction to Ambient

ermal Considerations							
Pac	kage	Symbol	Parameter				
QFN 3x3	DO 214	T _J	Operating Junction Temperature Range				
	D0-214	T,	Storage Temperature Range				

 T_{s}

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V-I Characteristics

TI



Normalized DC Holding Current vs. Case Temperature 2.0 1.8 ົວ Ratio of $\frac{1}{H}(T_c = 25)$ 1.6 .__ 1.4 25 °C 1.2 1.0 0.8 0.6 0.4 0 20 40 60 80 100 120 140 160 -40 -20 Case Temperature (T_C) – °C

V_{BR} vs. Junction Temperature



Value

-40 to +150

-65 to +150

DO-214: 90

QFN: 120

Unit

°C

°C

°C/W

LED Interference Test Circuit



6 LEDs in Series 50% Duty Cycle 10Khz

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5 LEDs and 1 PLED in Series 50% Duty Cycle 10Khz



Note: These two graphs show the current magnitude through the LED string with and without the PLED included. There is no noticeable effect on the LED current magnitude when the PLED is included in the circuit as compared to the LED current magnitude when the PLED is not in the circuit. (The conversion factor for the test measurement in the graphs above is 10mA/mV for the Pearson coil measurement, therefore, the current magnitude in the first figure is 10mA*8.9 = 89mA, while the second figure is 91mA.)



Channel 1: current through LEDs (318 mA) Channel 2: voltage across PLED device (4.5 V)

PLED device zeners and then turns fully on 10Khz



Channel 1: current through LEDs (346 mA) and PLED device once it is fully turned on 2.5 µsec later Channel 2: voltage across PLED device (21.3 V before PLED crowbars with 2 V drop)



Soldering Parameters

Reflow Co	ndition	Pb – Free assembly	
	-Temperature Min (T _{s(min)})	150°C	
Pre Heat	-Temperature Max (T _{s(max)})	200°C	
	-Time (min to max) (t_s)	60 – 180 secs	
Average ra (T _L) to pea	amp up rate (LiquidusTemp k	3°C/second max	
T _{S(max)} to T _L - Ramp-up Rate		3°C/second max	
Poflow	-Temperature (T _L) (Liquidus)	217°C	
nellow	-Temperature (t _L)	60 – 150 seconds	
PeakTemp	erature (T _P)	260 ^{+0/-5} °C	
Time withi Temperatu	n 5°C of actual peak ire (t _p)	30 seconds	
Ramp-dow	vn Rate	6°C/second max	
Time 25°C to peak Temperature (T _P)		8 minutes max	
Do not exc	eed	260°C	

Physical Specifications

Terminal Material	Copper Alloy
Terminal Finish	100% Matte Tin Plated
Body Material	UL recognized epoxy meeting flammability classification 94V-0



Environmental Specifications

High Temperature Voltage Blocking	MIL-STD-750: Method 1040, Condition A 80% min V _{DRM} (VAC-peak), 150°C, 504 hours
Temperature Cycling	MIL-STD-750: Method 1051 -65°C to 150°C, 15-minute dwell, 100 cycles
Biased Temperature & Humidity	EIA/JEDEC: JESD22-A101 52VDC, 85°C, 85%RH, 1008 hours
High Temperature Storage	MIL-STD-750: Method 1031 150°C, 1008 hours
Low Temperature Storage	-65°C, 1008 hours
Thermal Shock	MIL-STD-750: Method 1056 0°C to 100°C, 5-minute dwell, 10-second transfer, 10 cycles
Resistance to Solder Heat	MIL-STD-750: Method 2031 260°C, 10 seconds

PLED Open LED Protectors

PLED Series

Dimensions - QFN (3x3) Package

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Dimonsions		Inches		Ν	∕lillimeter	s
Dimensions	Min	Тур	Max	Min	Тур	Max
А	0.114	0.118	0.122	2.900	3.000	3.100
В	0.114	0.118	0.122	2.900	3.000	3.100
С	0.075	0.079	0.083	1.900	2.000	2.100
E	0.011	0.015	0.019	0.285	0.385	0.485
F	0.076	0.080	0.084	1.930	2.030	2.130
Н	0.035	0.039	0.043	0.900	1.000	1.100
J	0.000	0.004	0.008	0.000	0.100	0.200
K1	0.004	0.008	0.012	0.100	0.200	0.300
K2	0.004	0.008	0.012	0.100	0.200	0.300
M1	0.056	0.060	0.064	1.143	1.530	1.630
M2	0.038	0.042	0.046	0.970	1.070	1.170
N1	0.096	0.100	0.104	2.440	2.540	2.640
N2	0.082	0.086	0.090	2.080	2.180	2.280

Dimensions - DO-214 AA Package





Recommended Soldering Pad Outline

Dimonsiona	Inches		Millimeters		
DIMENSIONS	Min	Max	Min	Max	
А	0.130	0.156	3.30	3.95	
В	0.201	0.220	5.10	5.60	
С	0.077	0.087	1.95	2.20	
D	0.159	0.181	4.05	4.60	
E	0.030	0.063	0.75	1.60	
F	0.075	0.096	1.90	2.45	
G	0.002	0.008	0.05	0.20	
Н	0.077	0.104	1.95	2.65	
К	0.006	0.016	0.15	0.41	

PLED Open LED Protectors

PLED Series



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Package	Description	Packaging Quantity	Industry Standard			
Q12	QFN 3x3	5000	EIA-481-1			
S	DO-214	2500	EIA-481-1			

Tape and Reel Specification - QFN (3x3)

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Specifications are subject to change without notice

330.0

N/A

13.50

N/A

N/A

14.40

3.40

3.40

1.60

N/A

1.85

10.35

5.55

1.30

4.10

8.10

2.06

0.35

12.30

9.30

Component Spacing

Feed hole center-Pocket hole

Carrier Tape Thickness

Embossed Carrier Tape Width

Cover Tape Width

0.311

0.077

0.010

0.453

0.358

0.319

0.081

0.014

0.484

0.366

7.90

1.90

0.25

11.50

9.10



DO-214 Embossed Carrier Reel Pack (RP)

Meets all EIA-481-1 Standards

